#### **AMPMODU**

TE Internal #: 5-146277-6

PCB Mount Header, Vertical, Board-to-Board, 6 Position, 2.54 mm [. 1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal,

Black

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Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 6
Number of Rows: 1

### **Features**

### **Product Type Features**

PCB Connector Assembly Type	PCB Mount Header	
Connector System	Board-to-Board	
Header Type	Breakaway	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
PCB Mount Orientation	Vertical	
Number of Positions	6	

# **Body Features**

Number of Rows

Board-to-Board Configuration

Parallel

### **Contact Features**

PCB Contact Termination Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]	



Contact Underplating Material Thickness	1.27 μm[50 μin]
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	LCP
Dimensions	
PCB Thickness (Recommended)	1.6 mm[.063 in]
Usage Conditions	
Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Type	Carton



## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free
Solder Process Capability	Pin-in-Paste capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**



# Customers Also Bought

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### **Documents**

### **Product Drawings**

06 MODII HDR SRST B/A .100CL

English

### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_5-146277-6\_E.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5-146277-6\_E.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5-146277-6\_E.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**Product Environmental Compliance** 

PCB Mount Header, Vertical, Board-to-Board, 6 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, Black



### TE Material Declaration

English